

## Is Now Part of



## ON Semiconductor®

# To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to Fairchild <a href="guestions@onsemi.com">guestions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



**July 2010** 

## FDZ3N513ZT

## **Integrated NMOS and Schottky Diode**

## **Features**

- Monolithic NMOS and Schottky Diode
- Ultra-small form factor 1mm x 1mm WLCSP
- Max  $r_{DS(on)}$  = 462 m $\Omega$  at  $V_{GS}$  = 4.5 V,  $I_D$  = 0.3 A
- Max  $r_{DS(on)}$  = 520 m $\Omega$  at  $V_{GS}$  = 3.2 V,  $I_D$  = 0.3 A
- HBM ESD protection level > 2000V (Note3)
- RoHS Compliant

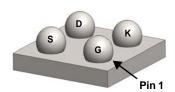
## **General Description**

The FDZ3N513ZT is a monolithic NMOS/ Schottky combination (FETky) and is designed and wired to function as a discontinuous conduction mode (DCM) boost LED power train for mobile LED backlighting applications.

## **Application**

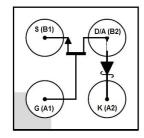
Boost Converter Power Train for single cell Li-ion LED backlighting











WL-CSP 1.0X1.0 Bumps Facing Up View

## **Absolute Maximum Ratings**

WL-CSP 3D Bumps Facing Up View

Symbol	Parameter	Ratings	Units	
V <sub>DS</sub>	NMOS Drain to Source Voltage		30	V
$V_{GS}$	NMOS Gate to Source Voltage	-0.3/5.5	V	
$P_{D}$	Power Dissipation @ T <sub>A</sub> = 25°C	1	W	
I <sub>D</sub>	Maximum Continuous NMOS Drain Current	1.1	Α	
$V_{RRM}$	Schottky Repetitive Peak Reverse Voltage	25	V	
Io	Schottky Average Forward Current		0.3	Α
T <sub>J</sub> , T <sub>STG</sub>	Operating Junction and Storage Temperature		-55/125	°C
ESD	Electrostatic Discharge Protection CDM 2000			

#### **Thermal Characteristics**

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient - 1in², 2oz. Copper	(Note 1a)	100	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient - Minimum Pad	(Note 1b)	260	°C/W

## **Package Marking and Ordering Information**

Part Number	Device Marking	Package	Reel Size	Tape Width	Quantity
FDZ3N513ZT	Z3	WL-CSP 1.0X1.0	7"	8mm	5000 units

## **Electrical Characteristics** T<sub>J</sub> = 25 °C unless otherwise noted

Symbol	Parameter	lest Conditions	Min	Іур	Max	Units
Off Chara	acteristics					
$BV_{DSS}$	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		47		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V			1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = +5 \text{ V}/-0.3 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μА

## **On Characteristics**

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 250 \mu A$	0.5	0.7	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		-1.6		mV/°C
r <sub>DS(on)</sub> Drain to Source On Resistance	Drain to Source On Bosistanes	$V_{GS} = 4.5 \text{ V}, I_D = 0.3 \text{ A}$		384	462	mΩ
	Drain to Source On Resistance	$V_{GS} = 3.2 \text{ V}, I_D = 0.3 \text{ A}$		410	520	1115.2
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 \text{ V}, I_{D} = 0.3 \text{ A}$		0.5		S

## **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	45 1/ 1/ 2/	45	85	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	45	85	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1 - 1 1/11/12	10	25	pF
$R_g$	Gate Resistance		2.0		Ω

## **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		3.1	10	ns
t <sub>r</sub>	Rise Time	$V_{DD} = 15 \text{ V}, I_{D} = 0.3 \text{ A}$	1.9	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 5 \text{ V}, R_{GEN} = 6 \Omega$	9.6	20	ns
t <sub>f</sub>	Fall Time		2.7	10	ns
$Q_g$	Total Gate Charge (V <sub>GS</sub> = 4.5 V)	.,	1.0		nC
$Q_{gs}$	Gate to Source Gate Charge	V <sub>DD</sub> = 15 V I <sub>D</sub> = 0.3 A	0.1		nC
$Q_{ad}$	Gate to Drain "Miller" Charge	I <sub>D</sub> = 0.3 A	0.3		nC

#### **Drain-Source Diode Characteristics**

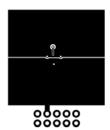
$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 0.3 \text{ A}$ (Note 2)		0.75	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	L = 0.3 A di/dt = 100 A/		16	29	ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = 0.3 A, di/dt = 100 A/μs		6.0	10	nC

## **Schottky Diode Characteristics**

I_	Reverse Leakage	V <sub>R</sub> = 20 V	T <sub>J</sub> = 25 °C	15	30	μΑ
'R	Neverse Leakage	VR - 20 V	$T_J = 85  ^{\circ}C$	300		μΑ
V	Forward Voltage	I <sub>F</sub> = 300 mA	T <sub>J</sub> = 25 °C	0.72	1.2	V
٧F	Forward Voltage	IF = 300 IIIA	$T_J = 85 ^{\circ}\text{C}$	0.74		V

#### Notes

<sup>1.</sup> R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> oz. copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0JA</sub> is determined by the user's board design.



a. 100 °C/W when mounted on a 1 in² pad of 2 oz copper.



 b. 260 °C/W when mounted on a minimum pad of 2 oz copper.

<sup>2.</sup> Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

<sup>3.</sup> The diode connected between the gate and source serves only as protection ESD. No gate overvoltage rating is implied.

## Typical Characteristics T<sub>J</sub> = 25°C unless otherwise noted

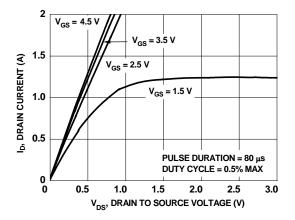


Figure 1. On Region Characteristics

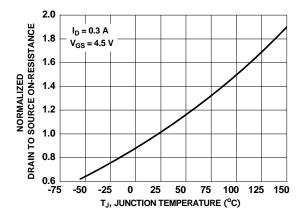


Figure 3. Normalized On Resistance vs Junction Temperature

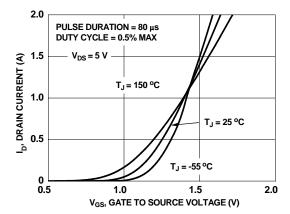


Figure 5. Transfer Characteristics

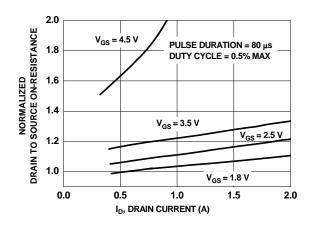


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

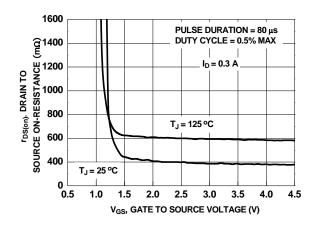


Figure 4. On-Resistance vs Gate to Source Voltage

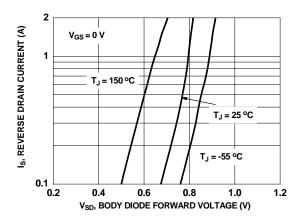


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

## Typical Characteristics T<sub>J</sub> = 25°C unless otherwise noted

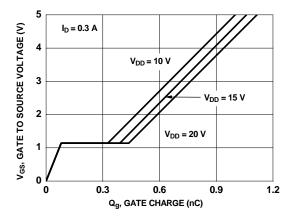
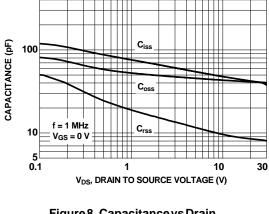


Figure 7. Gate Charge Characteristics



500

Figure 8. Capacitance vs Drain to Source Voltage

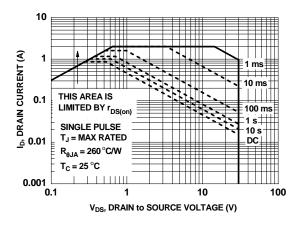


Figure 9. Forward Bias Safe Operating Area

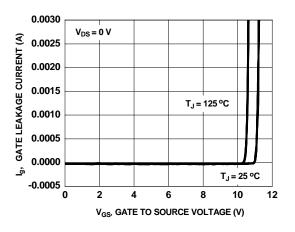


Figure 10. Gate Leakage Current vs Gate to Source Voltage

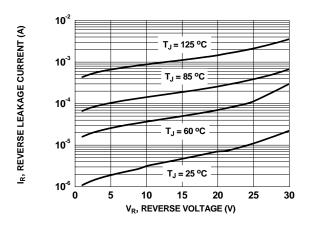


Figure 11. Schottky Diode Reverse Current

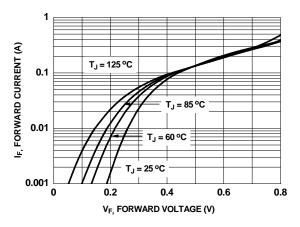


Figure 12. Schottky Diode Forward Voltage

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

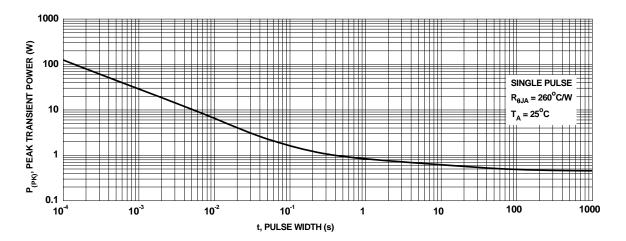


Figure 13. Single Pulse Maximum Power Dissipation

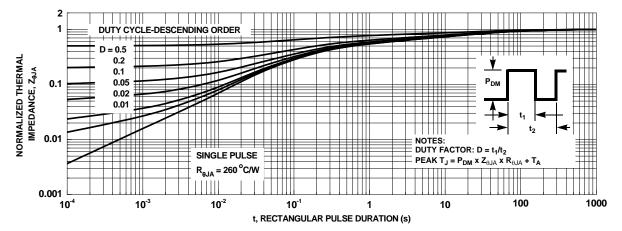
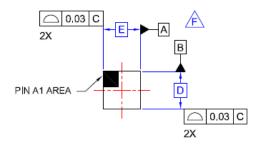
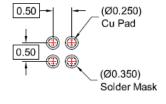


Figure 14. Junction-to-Ambient Transient Thermal Response Curve

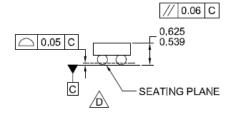
## **Dimensional Outline and Pad Layout**



TOP VIEW

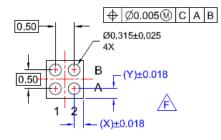


## RECOMMENDED LAND PATTERN (NSMD PAD TYPE)





SIDE VIEWS



**BOTTOM VIEW** 

## NOTES:

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
- DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E. PACKAGE NOMINAL HEIGHT IS 582 MICRONS ±43 MICRONS (539-625 MICRONS).

FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.

## **Product Specific Dimensions**

Product	D	E	Х	Y
FDZ3N513ZTUCX	1.000 +/-0.030	1.000 +/-0.030	0.018	0.018





#### **TRADEMARKS**

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

 $\begin{array}{lll} \mathsf{AccuPower^{\mathsf{TM}}} & & \mathsf{F-PFS^{\mathsf{TM}}} \\ \mathsf{Auto-SPM^{\mathsf{TM}}} & & \mathsf{FRFET}^{\otimes} \\ \end{array}$ 

Build it Now™ Global Power Resource SM CorePLUS™ Green FPS™

CorePOWER™ Green FPS™ e-Series™

 $\begin{array}{ccc} CROSSVOLT^{\text{TM}} & Gmax^{\text{TM}} \\ CTL^{\text{TM}} & GTO^{\text{TM}} \\ Current Transfer Logic^{\text{TM}} & IntelliMAX^{\text{TM}} \\ \end{array}$ 

Current I ranster Logic™ IntelliMAX™
DEUXPEED® ISOPLANAR™
Dual Cool™ MegaBuck™
EcoSPARK® MICROCOUPLER™
EfficientMax™ MicroFET™

FACT Quiet Series™

MicroPak™
MicroPak2™
MillerDrive™
MotionMax™
MotionSPM™
OptoHiT™
OPTOLOGIC
FAST®

MicroPak™
MillerDrive™
Motion-SPM™
OptoHiT™
OPTOLOGIC
OPTOLOGIC
OPTOLOGIC
OPTOLOGIC

FastvCore™ FETBench™ FlashWriter®\*

FlashWriter PDP SPMTM

Power-SPM™ PowerTrench® PowerXS™

Programmable Active Droop™

QFET<sup>®</sup>
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

SPM®
STEALTH™
SUPERSOT™-3
SUPERSOT™-3
SUPERSOT™-8
SUPERMOS™
SyncFET™
Sync-Lock™

Franchise
TinyBoost™
TinyBoost™
TinyBouck™
TinyCalc™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPower™
TinyPwM™
TinyWire™
TriFault Detect™
TRUECURRENT™\*

µSerDes™
UHC™

Littra ERFET™

The Power Franchise®

Ultra FRFET™ UniFET™ VCX™ VisualMax™ XS™

\* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

OPTOPLANAR®

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

#### As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### **ANTI-COUNTERFEITING POLICY**

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

#### **Definition of Terms**

Datasheet Identification		Definition
Advance Information Formative / In Design		Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary First Production		Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed Full Production		Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 148

ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="www.onsemi.com/site/pdt/Patent-Marking.pdf">www.onsemi.com/site/pdt/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

## **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800-282-9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by ON Semiconductor manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60\_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE222 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B